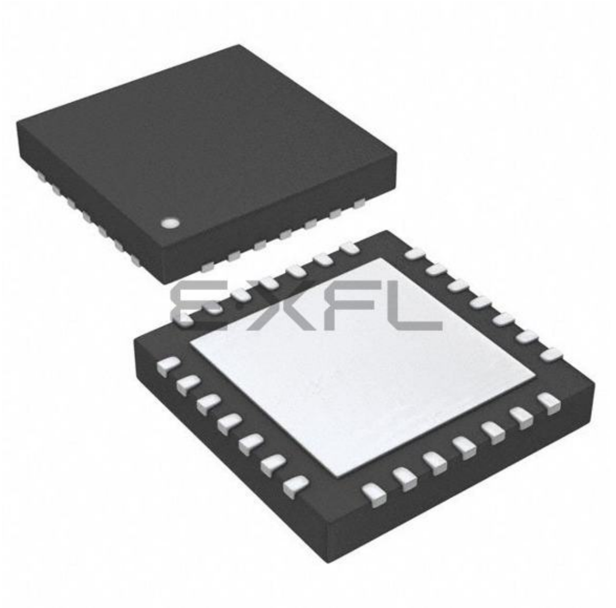

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	16
Program Memory Size	64KB (32K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	3.8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf26j11-i-ml

2.6 External Oscillator Pins

Many microcontrollers have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 2-5. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

In planning the application's routing and I/O assignments, ensure that adjacent port pins, and other signals in close proximity to the oscillator, are benign (i.e., free of high frequencies, short rise and fall times, and other similar noise).

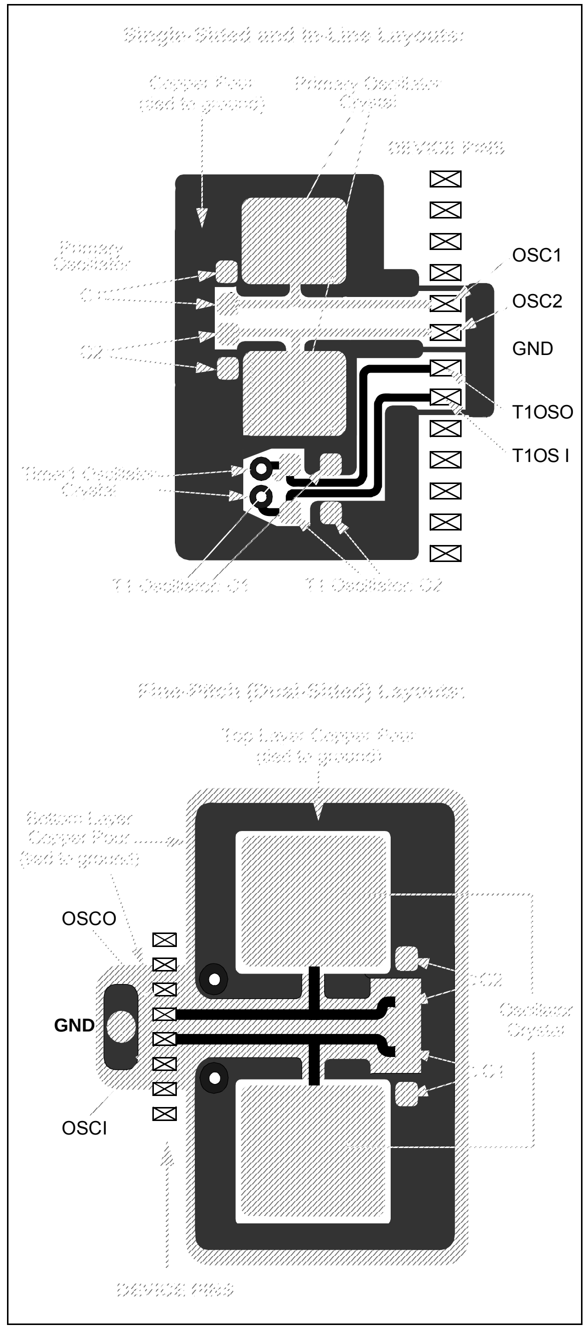
For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

- *AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC™ and PICmicro® Devices"*
- *AN849, "Basic PICmicro® Oscillator Design"*
- *AN943, "Practical PICmicro® Oscillator Analysis and Design"*
- *AN949, "Making Your Oscillator Work"*

2.7 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic low state. Alternatively, connect a 1 kΩ to 10 kΩ resistor to VSS on unused pins and drive the output to logic low.

FIGURE 2-5: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT



4.4.3 RC_IDLE MODE

In RC_IDLE mode, the CPU is disabled but the peripherals continue to be clocked from the internal oscillator block. This mode allows for controllable power conservation during Idle periods.

From RC_RUN, this mode is entered by setting the IDLEN bit and executing a `SLEEP` instruction. If the device is in another Run mode, first set IDLEN, then clear the SCS bits and execute `SLEEP`. When the clock source is switched to the INTOSC block, the primary oscillator is shut down and the OSTS bit is cleared.

When a wake event occurs, the peripherals continue to be clocked from the internal oscillator block. After the wake event, the CPU begins executing code being clocked by the INTRC. The IDLEN and SCS bits are not affected by the wake-up. The INTRC source will continue to run if either the WDT or the FSCM is enabled.

4.5 Exiting Idle and Sleep Modes

An exit from Sleep mode, or any of the Idle modes, is triggered by an interrupt, a Reset or a WDT time-out. This section discusses the triggers that cause exits from power-managed modes. The clocking subsystem actions are discussed in each of the power-managed modes sections (see **Section 4.2 “Run Modes”**, **Section 4.3 “Sleep Mode”** and **Section 4.4 “Idle Modes”**).

4.5.1 EXIT BY INTERRUPT

Any of the available interrupt sources can cause the device to exit from an Idle mode, or the Sleep mode, to a Run mode. To enable this functionality, an interrupt source must be enabled by setting its enable bit in one of the INTCON or PIE registers. The exit sequence is initiated when the corresponding interrupt flag bit is set.

On all exits from Idle or Sleep modes by interrupt, code execution branches to the interrupt vector if the GIE/GIEH bit (INTCON<7>) is set. Otherwise, code execution continues or resumes without branching (see **Section 9.0 “Interrupts”**).

4.5.2 EXIT BY WDT TIME-OUT

A WDT time-out will cause different actions depending on which power-managed mode the device is in when the time-out occurs.

If the device is not executing code (all Idle modes and Sleep mode), the time-out will result in an exit from the power-managed mode (see **Section 4.2 “Run Modes”** and **Section 4.3 “Sleep Mode”**). If the device is executing code (all Run modes), the time-out will result in a WDT Reset (see **Section 26.2 “Watchdog Timer (WDT)”**).

The WDT and postscaler are cleared by one of the following events:

- Executing a `SLEEP` or `CLRWDT` instruction
- The loss of a currently selected clock source (if the FSCM is enabled)

4.5.3 EXIT BY RESET

Exiting an Idle or Sleep mode by Reset automatically forces the device to run from the INTRC.

4.5.4 EXIT WITHOUT AN OSCILLATOR START-UP DELAY

Certain exits from power-managed modes do not invoke the OST at all. There are two cases:

- PRI_IDLE mode (where the primary clock source is not stopped) and the primary clock source is the EC mode
- PRI_IDLE mode and the primary clock source is the ECPLL mode

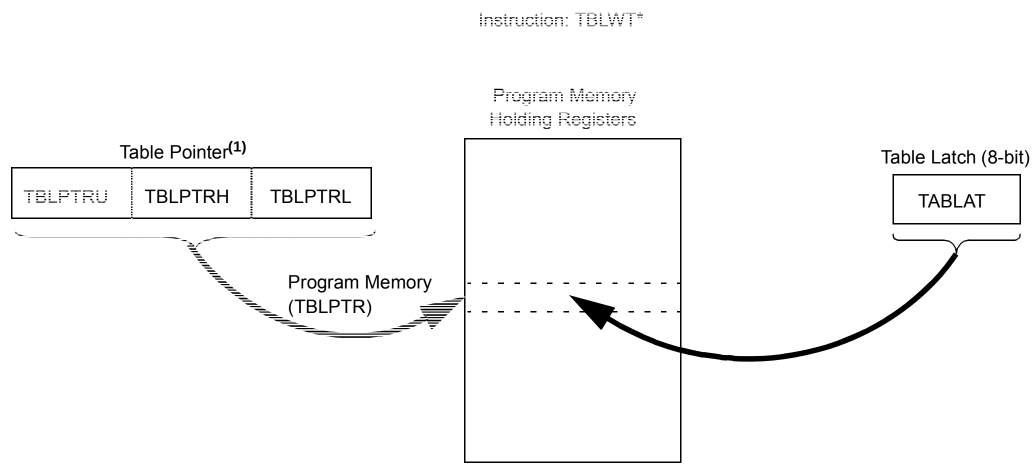
In these instances, the primary clock source either does not require an oscillator start-up delay, since it is already running (PRI_IDLE), or normally does not require an oscillator start-up delay (EC).

4.6 Deep Sleep Mode

Deep Sleep mode brings the device into its lowest power consumption state without requiring the use of external switches to remove power from the device. During deep sleep, the on-chip VDDCORE voltage regulator is powered down, effectively disconnecting power to the core logic of the microcontroller.

Note:	Since Deep Sleep mode powers down the microcontroller by turning off the on-chip VDDCORE voltage regulator, Deep Sleep capability is available only on PIC18FXXJ members in the device family. The on-chip voltage regulator is not available in PIC18LFXXJ members of the device family, and therefore, they do not support Deep Sleep.

FIGURE 7-2: TABLE WRITE OPERATION



Note 1: Table Pointer actually points to one of 64 holding registers, the address of which is determined by TBLPTRL<5:0>. The process for physically writing data to the program memory array is discussed in **Section 7.5 "Writing to Flash Program Memory"**.

7.2 Control Registers

Several control registers are used in conjunction with the `TBLRD` and `TBLWT` instructions. Those are:

- EECON1 register
- EECON2 register
- TABLAT register
- TBLPTR registers

7.2.1 EECON1 AND EECON2 REGISTERS

The EECON1 register (Register 7-1) is the control register for memory accesses. The EECON2 register is not a physical register; it is used exclusively in the memory write and erase sequences. Reading EECON2 will read all '`0`'s.

The WPROG bit, when set, will allow programming two bytes per word on the execution of the WR command. If this bit is cleared, the WR command will result in programming on a block of 64 bytes.

The FREE bit, when set, will allow a program memory erase operation. When FREE is set, the erase operation is initiated on the next WR command. When FREE is clear, only writes are enabled.

The WREN bit, when set, will allow a write operation. On power-up, the WREN bit is clear. The WRERR bit is set in hardware when the WR bit is set, and cleared when the internal programming timer expires and the write operation is complete.

Note:	During normal operation, the WRERR is read as '`1`'. This can indicate that a write operation was prematurely terminated by a Reset, or a write operation was attempted improperly.

The WR control bit initiates write operations. The bit cannot be cleared, only set, in software. It is cleared in hardware at the completion of the write operation.

EXAMPLE 7-3: WRITING TO FLASH PROGRAM MEMORY

```
                  MOVLW   CODE_ADDR_UPPER      ; Load TBLPTR with the base address
                  MOVWF   TBLPTRU              ; of the memory block, minus 1
                  MOVLW   CODE_ADDR_HIGH
                  MOVWF   TBLPTRH
                  MOVLW   CODE_ADDR_LOW
                  MOVWF   TBLPTRL
ERASE_BLOCK
                  BSF     EECON1, WREN         ; enable write to memory
                  BSF     EECON1, FREE         ; enable Erase operation
                  BCF     INTCON, GIE          ; disable interrupts
                  MOVLW   0x55
                  MOVWF   EECON2               ; write 55h
                  MOVLW   0xAA
                  MOVWF   EECON2               ; write 0AAh
                  BSF     EECON1, WR           ; start erase (CPU stall)
                  BSF     INTCON, GIE          ; re-enable interrupts
                  MOVLW   D'16'
                  MOVWF   WRITE_COUNTER        ; Need to write 16 blocks of 64 to write
                                               ; one erase block of 1024
RESTART_BUFFER
                  MOVLW   D'64'
                  MOVWF   COUNTER
                  MOVLW   BUFFER_ADDR_HIGH     ; point to buffer
                  MOVWF   FSR0H
                  MOVLW   BUFFER_ADDR_LOW
                  MOVWF   FSR0L
FILL_BUFFER
                  ...                          ; read the new data from I2C, SPI,
                                               ; PSP, USART, etc.
WRITE_BUFFER
                  MOVLW   D’64’                ; number of bytes in holding register
                  MOVWF   COUNTER
WRITE_BYTE_TO_HREGS
                  MOVFF   POSTINC0, WREG       ; get low byte of buffer data
                  MOVWF   TABLAT               ; present data to table latch
                  TBLWT+*                      ; write data, perform a short write
                                               ; to internal TBLWT holding register.
                  DECFSZ  COUNTER              ; loop until buffers are full
                  BRA     WRITE_BYTE_TO_HREGS
PROGRAM_MEMORY
                  BSF     EECON1, WREN         ; enable write to memory
                  BCF     INTCON, GIE          ; disable interrupts
                  MOVLW   0x55
    Required      MOVWF   EECON2               ; write 55h
    Sequence      MOVLW   0xAA
                  MOVWF   EECON2               ; write 0AAh
                  BSF     EECON1, WR           ; start program (CPU stall)
                  BSF     INTCON, GIE          ; re-enable interrupts
                  BCF     EECON1, WREN         ; disable write to memory

                  DECFSZ  WRITE_COUNTER        ; done with one write cycle
                  BRA     RESTART_BUFFER       ; if not done replacing the erase block
```

7.5.3 WRITE VERIFY

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

7.5.4 UNEXPECTED TERMINATION OF WRITE OPERATION

If a write is terminated by an unplanned event, such as loss of power or an unexpected Reset, the memory location just programmed should be verified and reprogrammed if needed. If the write operation is interrupted by a $\overline{\text{MCLR}}$ Reset or a WDT time-out Reset during normal operation, the user can check the WRERR bit and rewrite the location(s) as needed.

7.6 Flash Program Operation During Code Protection

See **Section 26.6 “Program Verification and Code Protection”** for details on code protection of Flash program memory.

TABLE 7-2: REGISTERS ASSOCIATED WITH PROGRAM FLASH MEMORY

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
TBLPTRU	—	—	bit 21	Program Memory Table Pointer Upper Byte (TBLPTR<20:16>)					69
TBPLTRH	Program Memory Table Pointer High Byte (TBLPTR<15:8>)								69
TBLPTRL	Program Memory Table Pointer Low Byte (TBLPTR<7:0>)								69
TABLAT	Program Memory Table Latch								69
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	69
EECON2	Program Memory Control Register 2 (not a physical register)								71
EECON1	—	—	WPROG	FREE	WRERR	WREN	WR	—	71

Legend: — = unimplemented, read as ‘0’. Shaded cells are not used during Flash program memory access.

Example 8-3 provides the instruction sequence for a 16 x 16 unsigned multiplication. Equation 8-1 provides the algorithm that is used. The 32-bit result is stored in four registers (RES<3:0>).

EQUATION 8-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

$$
\begin{aligned}
RES3{:}RES0 &= ARG1H{:}ARG1L \cdot ARG2H{:}ARG2L \\
&= (ARG1H \cdot ARG2H \cdot 2^{16}) + \\
&\quad (ARG1H \cdot ARG2L \cdot 2^{8}) + \\
&\quad (ARG1L \cdot ARG2H \cdot 2^{8}) + \\
&\quad (ARG1L \cdot ARG2L)
\end{aligned}
$$

EXAMPLE 8-3: 16 x 16 UNSIGNED MULTIPLY ROUTINE

```
    MOVF    ARG1L, W
    MULWF   ARG2L           ; ARG1L * ARG2L->
                            ; PRODH:PRODL
    MOVFF   PRODH, RES1     ;
    MOVFF   PRODL, RES0     ;

    MOVF    ARG1H, W
    MULWF   ARG2H           ; ARG1H * ARG2H->
                            ; PRODH:PRODL
    MOVFF   PRODH, RES3     ;
    MOVFF   PRODL, RES2     ;

    MOVF    ARG1L, W
    MULWF   ARG2H           ; ARG1L * ARG2H->
                            ; PRODH:PRODL
    MOVF    PRODL, W        ;
    ADDWF   RES1, F         ; Add cross
    MOVF    PRODH, W        ; products
    ADDWFC  RES2, F         ;
    CLRF    WREG            ;
    ADDWFC  RES3, F         ;

    MOVF    ARG1H, W        ;
    MULWF   ARG2L           ; ARG1H * ARG2L->
                            ; PRODH:PRODL
    MOVF    PRODL, W        ;
    ADDWF   RES1, F         ; Add cross
    MOVF    PRODH, W        ; products
    ADDWFC  RES2, F         ;
    CLRF    WREG            ;
    ADDWFC  RES3, F         ;
```

Example 8-4 provides the sequence to do a 16 x 16 signed multiply. Equation 8-2 provides the algorithm used. The 32-bit result is stored in four registers (RES<3:0>). To account for the sign bits of the arguments, the MSb for each argument pair is tested and the appropriate subtractions are done.

EQUATION 8-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

$$
\begin{aligned}
RES3{:}RES0 &= ARG1H{:}ARG1L \cdot ARG2H{:}ARG2L \\
&= (ARG1H \cdot ARG2H \cdot 2^{16}) + \\
&\quad (ARG1H \cdot ARG2L \cdot 2^{8}) + \\
&\quad (ARG1L \cdot ARG2H \cdot 2^{8}) + \\
&\quad (ARG1L \cdot ARG2L) + \\
&\quad (-1 \cdot ARG2H<7> \cdot ARG1H{:}ARG1L \cdot 2^{16}) + \\
&\quad (-1 \cdot ARG1H<7> \cdot ARG2H{:}ARG2L \cdot 2^{16})
\end{aligned}
$$

EXAMPLE 8-4: 16 x 16 SIGNED MULTIPLY ROUTINE

```
    MOVF    ARG1L, W
    MULWF   ARG2L           ; ARG1L * ARG2L ->
                            ; PRODH:PRODL
    MOVFF   PRODH, RES1     ;
    MOVFF   PRODL, RES0     ;

    MOVF    ARG1H, W
    MULWF   ARG2H           ; ARG1H * ARG2H ->
                            ; PRODH:PRODL
    MOVFF   PRODH, RES3     ;
    MOVFF   PRODL, RES2     ;

    MOVF    ARG1L, W
    MULWF   ARG2H           ; ARG1L * ARG2H ->
                            ; PRODH:PRODL
    MOVF    PRODL, W        ;
    ADDWF   RES1, F         ; Add cross
    MOVF    PRODH, W        ; products
    ADDWFC  RES2, F         ;
    CLRF    WREG            ;
    ADDWFC  RES3, F         ;

    MOVF    ARG1H, W        ;
    MULWF   ARG2L           ; ARG1H * ARG2L ->
                            ; PRODH:PRODL
    MOVF    PRODL, W        ;
    ADDWF   RES1, F         ; Add cross
    MOVF    PRODH, W        ; products
    ADDWFC  RES2, F         ;
    CLRF    WREG            ;
    ADDWFC  RES3, F         ;

    BTFSS   ARG2H, 7        ; ARG2H:ARG2L neg?
    BRA     SIGN_ARG1       ; no, check ARG1
    MOVF    ARG1L, W        ;
    SUBWF   RES2            ;
    MOVF    ARG1H, W        ;
    SUBWFB  RES3

SIGN_ARG1
    BTFSS   ARG1H, 7        ; ARG1H:ARG1L neg?
    BRA     CONT_CODE       ; no, done
    MOVF    ARG2L, W        ;
    SUBWF   RES2            ;
    MOVF    ARG2H, W        ;
    SUBWFB  RES3

CONT_CODE
   :
```

11.2 Slave Port Modes

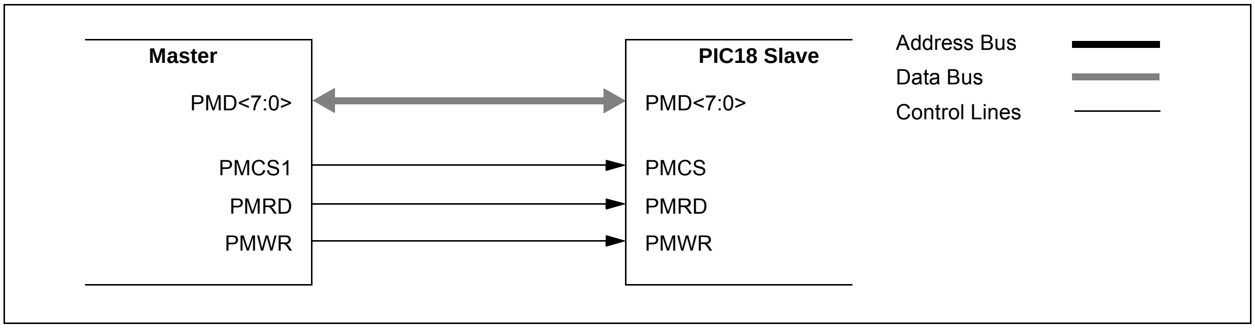
The primary mode of operation for the module is configured using the MODE<1:0> bits in the PMMODEH register. The setting affects whether the module acts as a slave or a master, and it determines the usage of the control pins.

11.2.1 LEGACY MODE (PSP)

In Legacy mode (PMMODEH<1:0> = `00` and PMPEN = `1`), the module is configured as a Parallel Slave Port (PSP) with the associated enabled module pins dedicated to the module. In this mode, an external device, such as another microcontroller or microprocessor, can asynchronously read and write data using the 8-bit data bus (PMD<7:0>), the read (PMRD), write (PMWR) and chip select (PMCS1) inputs. It acts as a slave on the bus and responds to the read/write control signals.

Figure 11-2 displays the connection of the PSP. When chip select is active and a write strobe occurs (PMCS = `1` and PMWR = `1`), the data from PMD<7:0> is captured into the PMDIN1L register.

FIGURE 11-2: LEGACY PARALLEL SLAVE PORT EXAMPLE



11.4.3 PARALLEL EEPROM EXAMPLE

Figure 11-30 provides an example connecting parallel EEPROM to the PMP. Figure 11-31 demonstrates a slight variation to this, configuring the connection for 16-bit data from a single EEPROM.

FIGURE 11-30: PARALLEL EEPROM EXAMPLE (UP TO 15-BIT ADDRESS, 8-BIT DATA)

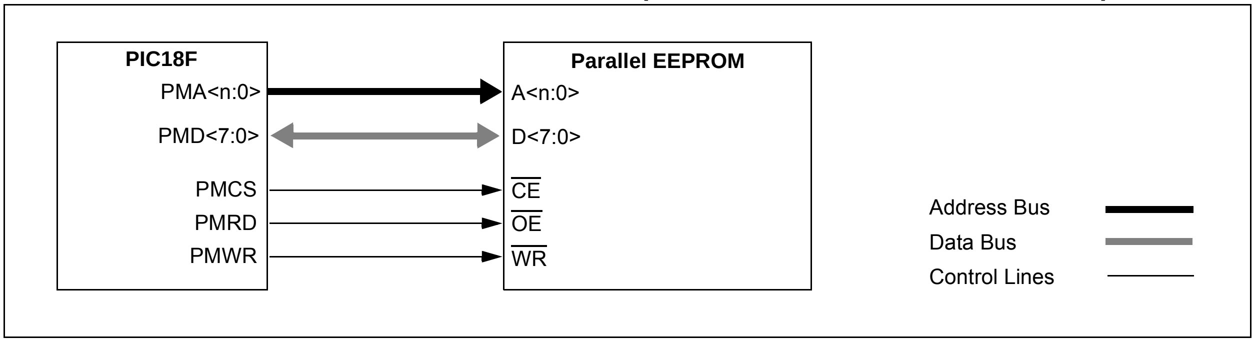
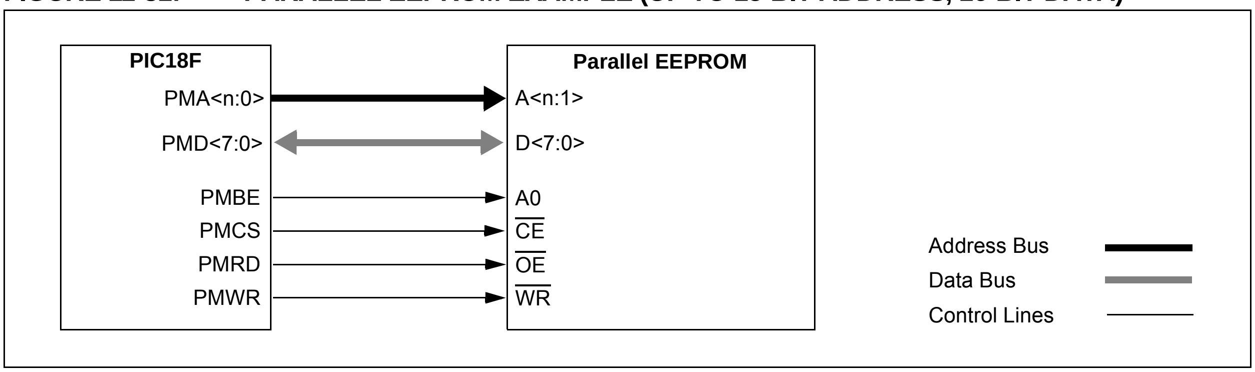


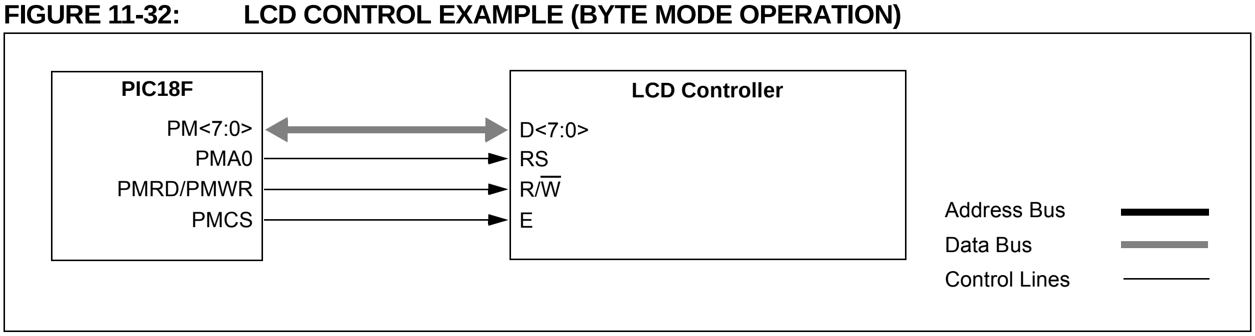
FIGURE 11-31: PARALLEL EEPROM EXAMPLE (UP TO 15-BIT ADDRESS, 16-BIT DATA)



11.4.4 LCD CONTROLLER EXAMPLE

The PMP module can be configured to connect to a typical LCD controller interface, as displayed in Figure 11-32. In this case, the PMP module is configured for active-high control signals since common LCD displays require active-high control.

FIGURE 11-32: LCD CONTROL EXAMPLE (BYTE MODE OPERATION)



17.1 RTCC MODULE REGISTERS

The RTCC module registers are divided into following categories:

RTCC Control Registers

- RTCCFG
- RTCCAL
- PADCFG1
- ALRMCFG
- ALRMRPT

RTCC Value Registers

- RTCVALH and RTCVALL – Can access the following registers
  - YEAR
  - MONTH
  - DAY
  - WEEKDAY
  - HOUR
  - MINUTE
  - SECOND

Alarm Value Registers

- ALRMVALH and ALRMVALL – Can access the following registers:
  - ALRMMNTH
  - ALRMDAY
  - ALRMWD
  - ALRMHR
  - ALRMMIN
  - ALRMSEC

Note:	The RTCVALH and RTCVALL registers can be accessed through RTCRPT<1:0>. ALRMVALH and ALRMVALL can be accessed through ALRMPTR<1:0>.

18.5.8 OPERATION IN POWER-MANAGED MODES

In Sleep mode, all clock sources are disabled. Timer2 will not increment and the state of the module will not change. If the ECCPx pin is driving a value, it will continue to drive that value. When the device wakes up, it will continue from this state. If Two-Speed Start-ups are enabled, the initial start-up frequency from HFINTOSC and the postscaler may not be stable immediately.

In PRI_IDLE mode, the primary clock will continue to clock the ECCPx module without change.

18.5.8.1 Operation with Fail-Safe Clock Monitor (FSCM)

If the Fail-Safe Clock Monitor (FSCM) is enabled, a clock failure will force the device into the power-managed RC_RUN mode and the OSCFIF bit of the PIR2 register will be set. The ECCPx will then be clocked from the internal oscillator clock source, which may have a different clock frequency than the primary clock.

18.5.9 EFFECTS OF A RESET

Both Power-on Reset and subsequent Resets will force all ports to Input mode and the ECCP registers to their Reset states.

This forces the ECCP module to reset to a state compatible with previous, non-enhanced ECCP modules used on other PIC18 and PIC16 devices.

TABLE 18-5: REGISTERS ASSOCIATED WITH ECCP1 MODULE AND TIMER1 TO TIMER3

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RABIE	TMR0IF	INT0IF	RABIF	69
RCON	IPEN	—	—	$\overline{RI}$	$\overline{TO}$	$\overline{PD}$	$\overline{POR}$	$\overline{BOR}$	70
PIR1	PMPIF(1)	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	72
PIE1	PMPIE(1)	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	72
IPR1	PMPIP(1)	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	72
PIR2	OSCFIF	CM2IF	CM1IF	—	BCL1IF	LVDIF	TMR3IF	CCP2IF	72
PIE2	OSCFIE	CM2IE	CM1IE	—	BCL1IE	LVDIE	TMR3IE	CCP2IE	72
IPR2	OSCFIP	CM2IP	CM1IP	—	BCL1IP	LVDIP	TMR3IP	CCP2IP	72
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	72
TMR1L	Timer1 Register Low Byte								70
TMR1H	Timer1 Register High Byte								70
TCLKCON	—	—	—	T1RUN	—	—	T3CCP2	T3CCP1	94
T1CON	TMR1CS1	TMR1CS0	T1CKPS1	T1CKPS0	T1OSCEN	$\overline{T1SYNC}$	RD16	TMR1ON	70
TMR2	Timer2 Register								70
T2CON	—	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0	70
PR2	Timer2 Period Register								70
TMR3L	Timer3 Register Low Byte								73
TMR3H	Timer3 Register High Byte								73
T3CON	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	—	$\overline{T3SYNC}$	RD16	TMR3ON	73
CCPR1L	Capture/Compare/PWM Register 1 Low Byte								72
CCPR1H	Capture/Compare/PWM Register 1 High Byte								72
CCP1CON	P1M1	P1M0	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	72
ECCP1AS	ECCP1ASE	ECCP1AS2	ECCP1AS1	ECCP1AS0	PSS1AC1	PSS1AC0	PSS1BD1	PSS1BD0	70
ECCP1DEL	P1RSEN	P1DC6	P1DC5	P1DC4	P1DC3	P1DC2	P1DC1	P1DC0	72

Legend: — = unimplemented, read as '0'. Shaded cells are not used during ECCP operation.

Note 1: These bits are only available on 44-pin devices.

EXAMPLE 20-1: CALCULATING BAUD RATE ERROR

```
For a device with Fosc of 16 MHz, desired baud rate of 9600, Asynchronous mode, and
8-bit BRG:
Desired Baud Rate = Fosc/(64 ([SPBRGHx:SPBRGx] + 1))
Solving for SPBRGHx:SPBRGx:
   X  =  ((Fosc/Desired Baud Rate)/64) – 1
      =  ((16000000/9600)/64) – 1
      =  [25.042] = 25
Calculated Baud Rate=16000000/(64 (25 + 1))
      =  9615
Error =  (Calculated Baud Rate – Desired Baud Rate)/Desired Baud Rate
      =  (9615 – 9600)/9600 = 0.16%
```

TABLE 20-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
TXSTAx	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	71
RCSTAx	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	71
BAUDCONx	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	73
SPBRGHx	EUSARTx Baud Rate Generator Register High Byte								73
SPBRGx	EUSARTx Baud Rate Generator Register Low Byte								71

Legend: — = unimplemented, read as ‘0’. Shaded cells are not used by the BRG.

20.3.2 EUSART SYNCHRONOUS MASTER RECEPTION

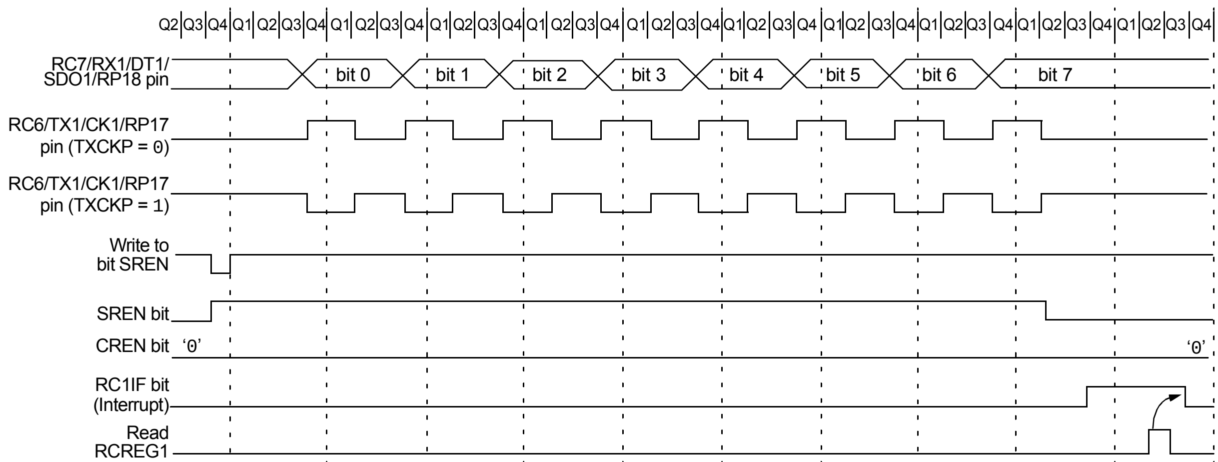
Once Synchronous mode is selected, reception is enabled by setting either the Single Receive Enable bit, SREN (RCSTAx<5>) or the Continuous Receive Enable bit, CREN (RCSTAx<4>). Data is sampled on the RXx pin on the falling edge of the clock.

If enable bit, SREN, is set, only a single word is received. If enable bit, CREN, is set, the reception is continuous until CREN is cleared. If both bits are set, then CREN takes precedence.

To set up a Synchronous Master Reception:

1. Initialize the SPBRGHx:SPBRGx registers for the appropriate baud rate. Set or clear the BRG16 bit, as required, to achieve the desired baud rate.
2. Enable the synchronous master serial port by setting bits, SYNC, SPEN and CSRC.
3. Ensure bits, CREN and SREN, are clear.
4. If interrupts are desired, set enable bit, RCxIE.
5. If 9-bit reception is desired, set bit, RX9.
6. If a single reception is required, set bit, SREN. For continuous reception, set bit, CREN.
7. Interrupt flag bit, RCxIF, will be set when reception is complete and an interrupt will be generated if the enable bit, RCxIE, was set.
8. Read the RCSTAx register to get the ninth bit (if enabled) and determine if any error occurred during reception.
9. Read the 8-bit received data by reading the RCREGx register.
10. If any error occurred, clear the error by clearing bit, CREN.
11. If using interrupts, ensure that the GIE and PEIE bits in the INTCON register (INTCON<7:6>) are set.

FIGURE 20-13: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)



Note: Timing diagram demonstrates Sync Master mode with bit SREN = 1 and bit BRGH = 0. This example is equally applicable to EUSART2 (RPn1/TX2/CK2 and RPn2/RX2/DT2).

REGISTER 25-3: CTMUICON: CTMU CURRENT CONTROL REGISTER (ACCESS FB1h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7-2 **ITRIM<5:0>:** Current Source Trim bits

`011111` = Maximum positive change from nominal current
`011110`
.
.
.
`000001` = Minimum positive change from nominal current
`000000` = Nominal current output specified by IRNG<1:0>
`111111` = Minimum negative change from nominal current
.
.
.
`100010`
`100001` = Maximum negative change from nominal current

bit 1-0 **IRNG<1:0>:** Current Source Range Select bits

`11` = 100 × Base current
`10` = 10 × Base current
`01` = Base current level (0.55 μA nominal)
`00` = Current source disabled

TABLE 25-1: REGISTERS ASSOCIATED WITH CTMU MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page:
CTMUCONH	CTMUEN	—	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	—	71
CTMUCONL	EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1	EDG1SEL0	EDG2STAT	EDG1STAT	71
CTMUICON	ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG0	71

Legend: — = unimplemented, read as ‘0’. Shaded cells are not used during ECCP operation.

ANDWF **AND W with f**

Syntax:	ANDWF f {,d {,a}}
Operands:	0 ≤ f ≤ 255 d ∈ [0,1] a ∈ [0,1]
Operation:	(W) .AND. (f) → dest
Status Affected:	N, Z
Encoding:	`0001` `01da` `ffff` `ffff`
Description:	The contents of W are ANDed with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank (default). If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See **Section 27.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.
Words:	1
Cycles:	1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: `ANDWF REG, 0, 0`

Before Instruction
W = 17h
REG = C2h
After Instruction
W = 02h
REG = C2h

BC **Branch if Carry**

Syntax:	BC n
Operands:	-128 ≤ n ≤ 127
Operation:	if Carry bit is '1', (PC) + 2 + 2n → PC
Status Affected:	None
Encoding:	`1110` `0010` `nnnn` `nnnn`
Description:	If the Carry bit is '1', then the program will branch. The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.
Words:	1
Cycles:	1(2)

Q Cycle Activity:
If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation

Example: `HERE BC 5`

Before Instruction
PC = address (HERE)
After Instruction
If Carry = 1;
PC = address (HERE + 12)
If Carry = 0;
PC = address (HERE + 2)

BRA — **Unconditional Branch**

Syntax: BRA n

Operands: $-1024 \leq n \leq 1023$

Operation: $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding:

`1101`	`0nnn`	`nnnn`	`nnnn`

Description: Add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a two-cycle instruction.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

Example: `HERE    BRA  Jump`

Before Instruction
PC = address (`HERE`)
After Instruction
PC = address (`Jump`)

BSF — **Bit Set f**

Syntax: BSF f, b {,a}

Operands: $0 \leq f \leq 255$
$0 \leq b \leq 7$
$a \in [0,1]$

Operation: `1` → f<b>

Status Affected: None

Encoding:

`1000`	`bbba`	`ffff`	`ffff`

Description: Bit 'b' in register 'f' is set.

If 'a' is '`0`', the Access Bank is selected. If 'a' is '`1`', the BSR is used to select the GPR bank (default).

If 'a' is '`0`' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \leq 95$ (5Fh). See **Section 27.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: `BSF    FLAG_REG, 7, 1`

Before Instruction
FLAG_REG = 0Ah
After Instruction
FLAG_REG = 8Ah

LFSR **Load FSR**

Syntax:	LFSR f, k
Operands:	$0 \leq f \leq 2$ $0 \leq k \leq 4095$
Operation:	$k \rightarrow$ FSRf
Status Affected:	None

Encoding:

`1110`	`1110`	`00ff`	k_{11}`kkk`
`1111`	`0000`	k_7`kkk`	`kkkk`

Description: The 12-bit literal ‘k’ is loaded into the file select register pointed to by ‘f’.

Words: 2

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal ‘k’ MSB	Process Data	Write literal ‘k’ MSB to FSRfH
Decode	Read literal ‘k’ LSB	Process Data	Write literal ‘k’ to FSRfL

Example: `LFSR 2, 0x3AB`

After Instruction
FSR2H = 03h
FSR2L = ABh

MOVF **Move f**

Syntax:	MOVF f {,d {,a}}
Operands:	$0 \leq f \leq 255$ $d \in [0,1]$ $a \in [0,1]$
Operation:	$f \rightarrow$ dest
Status Affected:	N, Z

Encoding:

`0101`	`00da`	`ffff`	`ffff`

Description: The contents of register ‘f’ are moved to a destination dependent upon the status of ‘d’. If ‘d’ is ‘0’, the result is placed in W. If ‘d’ is ‘1’, the result is placed back in register ‘f’ (default). Location ‘f’ can be anywhere in the 256-byte bank.

If ‘a’ is ‘0’, the Access Bank is selected. If ‘a’ is ‘1’, the BSR is used to select the GPR bank (default).

If ‘a’ is ‘0’ and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \leq 95$ (5Fh). See **Section 27.2.3 “Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode”** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

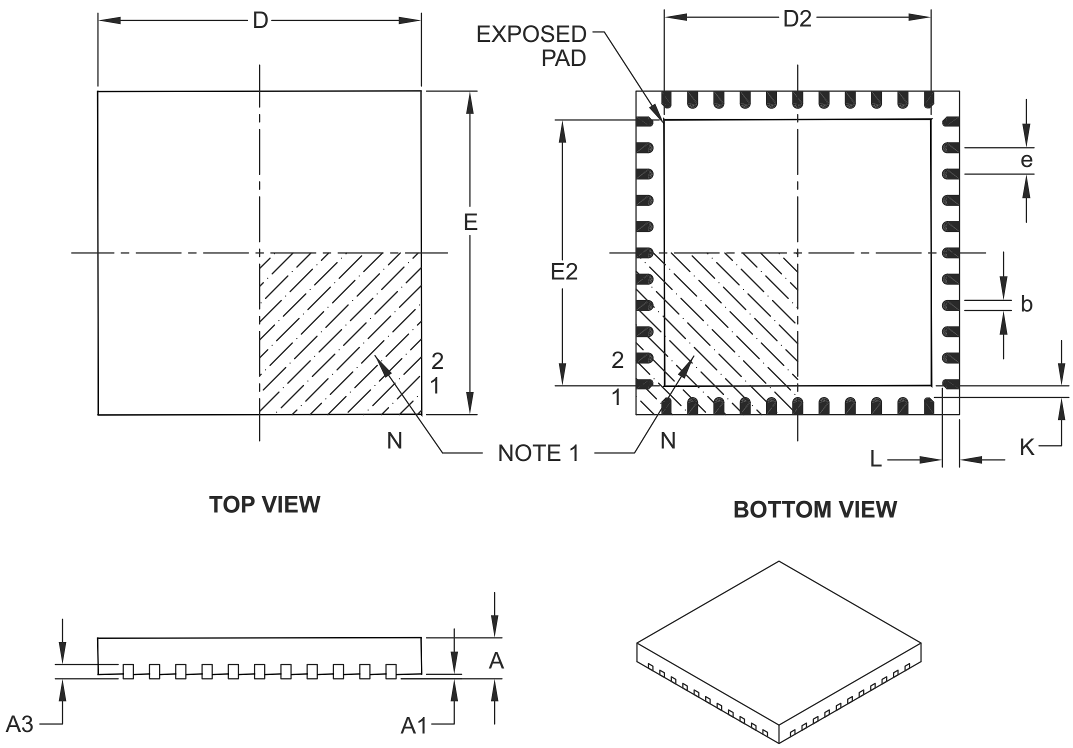
Q1	Q2	Q3	Q4
Decode	Read register ‘f’	Process Data	Write W

Example: `MOVF REG, 0, 0`

Before Instruction
REG = 22h
W = FFh
After Instruction
REG = 22h
W = 22h

44-Lead Plastic Quad Flat, No Lead Package (ML) – 8x8 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		44	
Pitch	e		0.65 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Width	E		8.00 BSC	
Exposed Pad Width	E2	6.30	6.45	6.80
Overall Length	D		8.00 BSC	
Exposed Pad Length	D2	6.30	6.45	6.80
Contact Width	b	0.25	0.30	0.38
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	–	–

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-103B

APPENDIX A: REVISION HISTORY

Revision A (October 2008)

Original data sheet for the PIC18F46J11 family of devices.

Revision B (February 2009)

Changes to the Electrical Characteristics and minor edits throughout text.

Revision C (October 2009)

Removed “Preliminary” marking.

Revision D (March 2011)

Committed data sheet errata changes and minor corrections throughout text.

APPENDIX B: DEVICE DIFFERENCES

The differences between the devices listed in this data sheet are shown in Table B-1,

TABLE B-1: DEVICE DIFFERENCES BETWEEN PIC18F46J11 FAMILY MEMBERS

Features	PIC18F24J11	PIC18F25J11	PIC18F26J11	PIC18F44J11	PIC18F45J11	PIC18F46J11
Program Memory	16K	32K	64K	16K	32K	64K
Program Memory (Instructions)	8,192	16,384	32,768	8,192	16,384	32,768
I/O Ports (Pins)	Ports A, B, C			Ports A, B, C, D, E		
10-Bit ADC Module	10 Input Channels			13 Input Channels		
Packages	28-Pin QFN, SOIC, SSOP and SPDIP (300 mil)			44-Pin QFN and TQFP		

L

M

N